

#### SB3200

Technical Data Data Sheet N0091, Rev.A RoHS 🗭

SB3200 SCHOTTKY RECTIFIER



#### Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- High Current Capability
- Low Power Loss, High Efficiency
- High Surge Current Capability
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Terminals finish: 100% Pure Tin
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

#### **Applications**

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Disk drives
- Battery charging

#### Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	Vrrm V <sub>rwm</sub> Vr	-	200	V
Average Rectified Forward Current	I <sub>F (AV)</sub>	50% duty cycle @T <sub>A</sub> =25°C, rectangular wave form	3	А
Peak One Cycle Non-Repetitive Surge Current	I <sub>FSM</sub>	8.3 ms, half Sine pulse, $T_C$ =25°C	80	A

#### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V <sub>F1</sub>	@ 3A, Pulse, T <sub>J</sub> = 25 °C	0.81	0.90	V
	V <sub>F2</sub>	@ 3A, Pulse, T <sub>J</sub> = 125 °C	0.68	0.75	V
Reverse Current*	I <sub>R1</sub>	$@V_R$ = Rated V <sub>R</sub> , Pulse, T <sub>J</sub> = 25 °C	0.0001	1.0	mA
	I <sub>R2</sub>	$@V_R$ = Rated V <sub>R</sub> , Pulse, T <sub>J</sub> = 125 °C	0.04	6	mA
Junction Capacitance	Ст	@V <sub>R</sub> = 5V, T <sub>C</sub> = 25 °C f <sub>SIG</sub> = 1MHz	130	150	pF
Voltage Rate of Change	dv/dt	10,000		V/μs	

\* Pulse width < 300 μs, duty cycle < 2%

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## **Circuit Diagram**





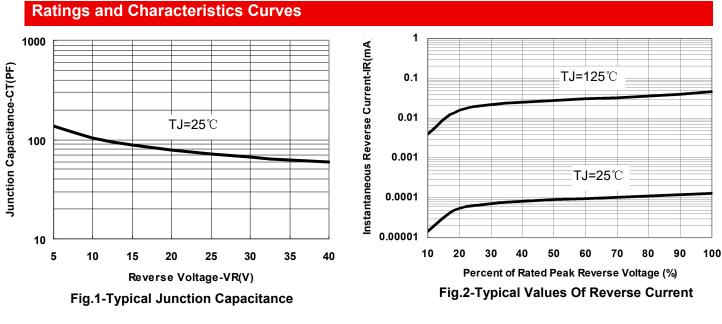
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## **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +150	°C
Typical Thermal Resistance Junction to Ambient	$R_{ heta JA}$	DC operation	25	°C/W
Approximate Weight	wt	-	1.02	g



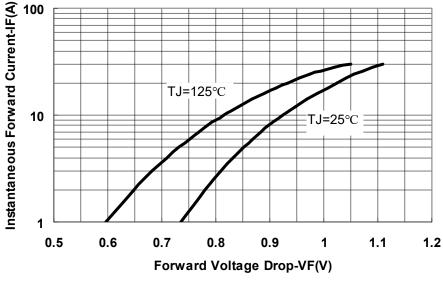


Fig.3-Typical Forward Voltage Drop Characteristics

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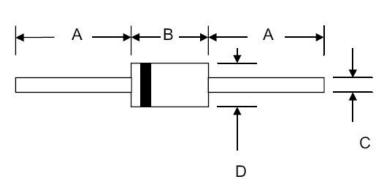


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#### **Mechanical Dimensions DO-201AD**



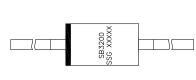
OVMDOL	Millim	neters	Inches	
SYMBOL	Min.	Max.	Min.	Max.
А	25.4	-	1.000	-
В	8.50	9.50	0.335	0.374
С	1.2	1.3	0.048	0.052
D	5.0	5.6	0.197	0.220

#### **Ordering Information**

Device	Package	Shipping	
SB3200	DO-201AD	1250pcs / tape	
	(Pb-Free)		

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

#### **Marking Diagram**



Where XXXXX is YYWWL

SSG YY

ww

L

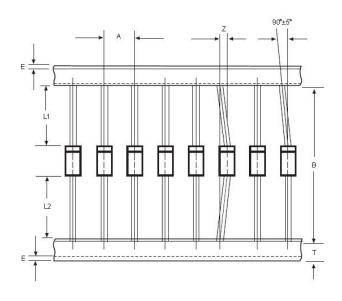
- SB3200 = Part Name
  - = SSG
  - = Year

= Week

= Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

#### **Carrier Tape Specification DO-201AD**



SYMBOL	Millimeters		
	Min.	Max.	
A	9.50	10.50	
В	50.9	53.9	
Z	-	1.20	
Т	5.60	6.40	
E	-	0.80	
IL1-L2I	-	1.0	



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